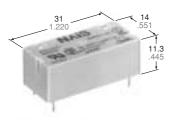




IC DRIVABLE PC BOARD RELAY FOR FIELD LOAD SWITCHING

ST RELAYS



FEATURES

- Sealed to meet the combination process of automatic wave soldering and cleaning needs
- · Latching types available
- High switching capacity and high sensitivity in subminiature size
 150 mW pick-up, 8 A inrush capacity:
 51 A for 1a1b, 35 A for 2a
- High shock and vibration resistance Shock: 20 G, Vibration: 10 to 55 Hz at double amplitude of 2 mm

mm inch

SPECIFICATIONS

Contacts

Arrangement	t		1 Form A 1 Form B	2 Form A	
Contact mate	erial		Gold flash over silver alloy		
Initial contact resistance, max.			30 mΩ		
	Max. switc	hing power	2,000 VA, 150 W		
Rating	Max. switc	hing voltage	380 V AC, 250 V DC		
(resistive)	Max. switc	hing current	8 A		
	Min. switcl	hing capacity#1	100 mA, 5 V DC		
HP rating			1/4 HP 125, 250 V AC		
Inrush current capability			51 A (TV-3 equivalence) for 1a1b 35 A (TV-1 equivalence) for 2a		
	Mechanica	al (at 180 cpm)	10 ⁷		
Expected life (min. operations)	Electrical	8 A 250 V AC (resistive)	10⁵		
		5 A 30 V DC (resistive)	2 × 10 ⁵		
		3 A 100 V AC (lamp)	3×10 ⁴	_	
		1 A 100 V AC (lamp)	_	3×10 ⁴	

Coil (polarized) (at 25°C 77°F)

	•	
Single side stable	Nominal operating power	Approx. 240 mW
Latching	Nominal set and reset power	Approx. 240 mW

^{#1} This value can change due to the switching frequency, environmental conditions, and desired reliability level, therefore it is recommended to check this with the actual load.

Remarks

- * Specifications will vary with foreign standards certification ratings.
- *1 Measurement at same location as "Initial breakdown voltage" section
- *2 Detection current: 10 mA
- *3 Wave is standard shock voltage of $\pm 1.2 \times 50 \mu s$ according to JEC-212-1981
- *4 Excluding contact bounce time
- *5 Half-wave pulse of sine wave: 11ms; detection time: 10μs
- *6 Half-wave pulse of sine wave: 6ms
- $^{\star 7}$ Detection time: $10 \mu s$
- *8 Refer to 6. Conditions for operation, transport and storage mentioned in AMBIENT ENVIRONMENT

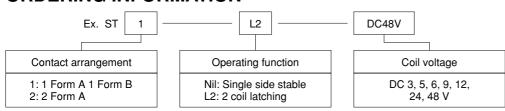
Characteristics (at 25°C 77°F 50% Relative humidity)

Max. operating speed 20 cpm (at rated linitial insulation resistance*1 1,000 MΩ (at 500 linitial stream) Initial breakdown voltage*2 Between contact sets 2,000 Vrms Between contacts 1,200 Vrms Between contacts and coil 3,750 Vrms	V DC)	
Initial Between contact sets 2,000 Vrms breakdown Between open contacts 1,200 Vrms	,	
breakdown Between open contacts 1,200 Vrms		
breakdown Between open contacts 1,200 Vrms		
voltage*2 Between contacts and coil 3,750 Vrms		
	,	
Surge voltage between coil and contact*3 Min. 6,000 V	'	
Operate time*4 (at nominal voltage) Max. 15 ms (Approx	. 10 ms)	
Release time (without diode)*4 (at nominal voltage) Max. 10 ms (Approx	x. 8 ms)	
Set time*4 (latching) (at nominal voltage) Max. 10 ms (Approx	Max. 10 ms (Approx. 8 ms)	
Reset time*4 (latching) (at nominal voltage) Max. 10 ms (Approx	k. 8 ms)	
Temperature rise Max. 55°C with nominal (at 60°C) and at 8 A switching		
Shock Functional*5 Min. 196 m/s² {20	0 G}	
resistance Destructive*6 Min. 980 m/s² {10	00 G}	
Vibration Functional*7 117.6 m/s² {12 G}, 10 at double amplitude		
resistance Destructive 176.4 m/s² {18 G}, 10 at double amplitude		
Conditions for operation, transport and storage*8 temp. Ambient $-40^{\circ}\text{C to } +60^{\circ}$ temp. $-40^{\circ}\text{Fto } +140^{\circ}$	-	
(Not freezing and condensing at low temperature) Humidity 5 to 85% R.H	l.	
Unit weight Approx. 10g .350	3 oz	
Unit weight Approx. 10g .353	3 oz	

TYPICAL APPLICATIONS

Sequence controllers, facsimiles, telephone controls, remote control security devices and security equipment.

ORDERING INFORMATION



(Notes) 1. Standard packing: Carton; 50 pcs., Case; 500 pcs.

2. 1 coil latching type available.

TYPES AND COIL DATA (at 20°C 68°F)

Single side stable

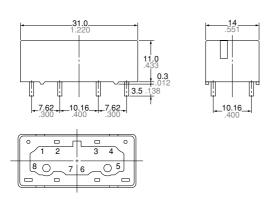
Part No.		Nominal	Diek up voltage	Drop-out	Maximum	Coil resistance,	Nominal
1 Form A 1 Form B	2 Form A	voltage, V DC	Pick-up voltage, V DC (max.)	voltage, V DC (min.)	allowable voltage, V DC (60°C 140°F)	Ω (±10%)	operating current, mA
ST1-DC3V	ST2-DC3V	3	2.4	0.3	4.5	38	78.9
ST1-DC5V	ST2-DC5V	5	4.0	0.5	7.5	105	47.6
ST1-DC6V	ST2-DC6V	6	4.8	0.6	9.0	150	40
ST1-DC9V	ST2-DC9V	9	7.2	0.9	13.5	360	25
ST1-DC12V	ST2-DC12V	12	9.6	1.2	18.0	600	20
ST1-DC24V	ST2-DC24V	24	19.2	2.4	36.0	2,400	10
ST1-DC48V	ST2-DC48V	48	38.4	4.8	72.0	9,000	5.3

2 coil latching

Part No.		Nominal	Set and reset	Maximum allowable voltage,	Coil resistance.	Nominal
1 Form A 1 Form B	2 Form A	voltage, V DC	voltage, V DC (max.)	V DC (60°C 140°F)	Ω (±10%)	operating current, mA
ST1-L2-DC3V	ST2-L2-DC3V	3	2.4	4.5	40	75
ST1-L2-DC5V	ST2-L2-DC5V	5	4.0	7.5	110	45.5
ST1-L2-DC6V	ST2-L2-DC6V	6	4.8	9.0	155	38.7
ST1-L2-DC9V	ST2-L2-DC9V	9	7.2	13.5	360	25
ST1-L2-DC12V	ST2-L2-DC12V	12	9.6	18.0	640	18.8
ST1-L2-DC24V	ST2-L2-DC24V	24	19.2	36.0	2,400	10
ST1-L2-DC48V	ST2-L2-DC48V	48	38.4	72.0	10,200	4.7

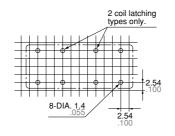
DIMENSIONS

mm inch



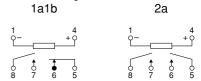
General tolerance: ±0.2 ±.008

PC board pattern (Copper-side view)



Tolerance: ±0.1 ±.004

Schematic (Bottom view) Single side stable



(Deenergized condition)

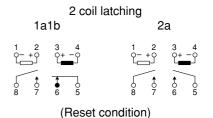
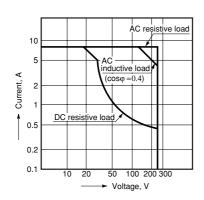


Diagram shows the "reset" position when terminals 3 and 4 are energized. Energize terminals 1 and 2 to transfer contacts.

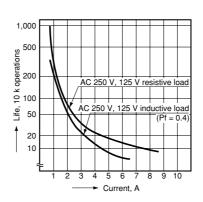
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REFERENCE DATA

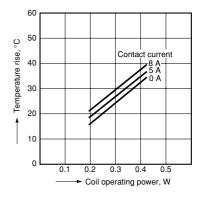
1. Max. switching power



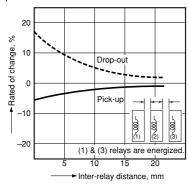
2. Life curve



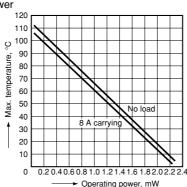
3. Coil temperature rise Sample: ST1-DC24V



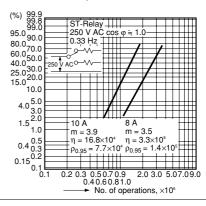
4. Influence of adjacent mounting Sample: ST1-DC24V



5. Max. ambient temperature by operating power



6. Contact reliability



mm inch

ST relay socket



ST-SS Solder terminal socket

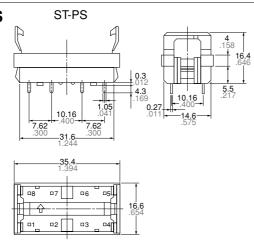


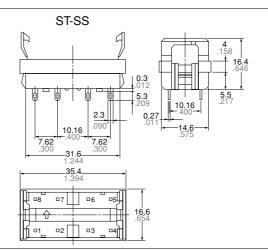
ST-PS
PC board terminal socket

Specifications

Breakdown voltage	4,000 Vrms Coil/Contacts 2,000 Vrms Contacts/Contacts
Insulation resistance	More than 1,000 M Ω between terminals
Heat resistance	150°C (302°F) for 1 hr
Max. continuous current	10 A
Relay insertion life	15 times

DIMENSIONS





Precautions for use (socket)

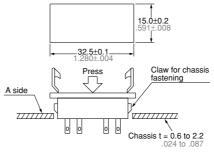
1. PC board mounting method

PC board pattern



2. Chassis cutout

Chassis cutting dimensions



If the chassis hole is punched with a press, set so the release R on the front side (A side).

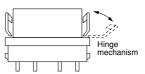
The range for chassis thickness is 0.6 to 2.2 mm .024 to .087 inch.

3. Relay mounting and removal

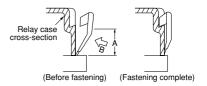
(1) Align the directions of the relay and socket.



(2) Insert the relay all the way in, so it is securely in place.



(3) Press the part indicated by A in the B direction, and fasten by placing the hook on the relay



(4). When removing the relay, completely release the hooks on both sides and pull the relay out.